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(54) **THREE-DIMENSIONAL PRINTING APPARATUS**

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(58) **Field of Classification Search**

None
See application file for complete search history.

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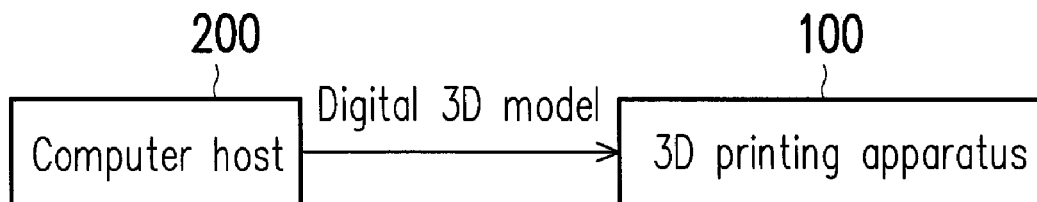
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(57) **ABSTRACT**

A three-dimensional (3D) apparatus including a processing unit, a base and a printing head is provided. The processing unit is configured to read and process digital 3D model information. The base is coupled to and controlled by the processing unit. The base includes a plurality of heating regions. The processing unit is configured to selectively heat at least one of the heating regions according to the digital 3D model information. The printing head is disposed above the base. The printing head is coupled to and controlled by the processing unit to dispense a thermal melting material layer-by-layer on the heated heating region to form a 3D object related to the digital 3D model information.

7 Claims, 4 Drawing Sheets



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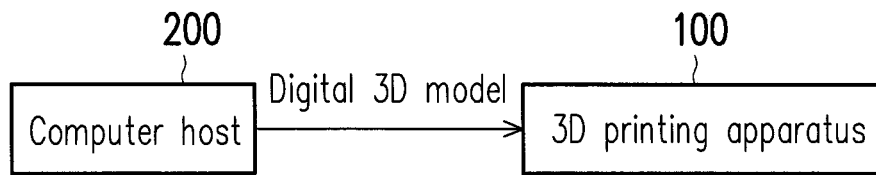


FIG. 1

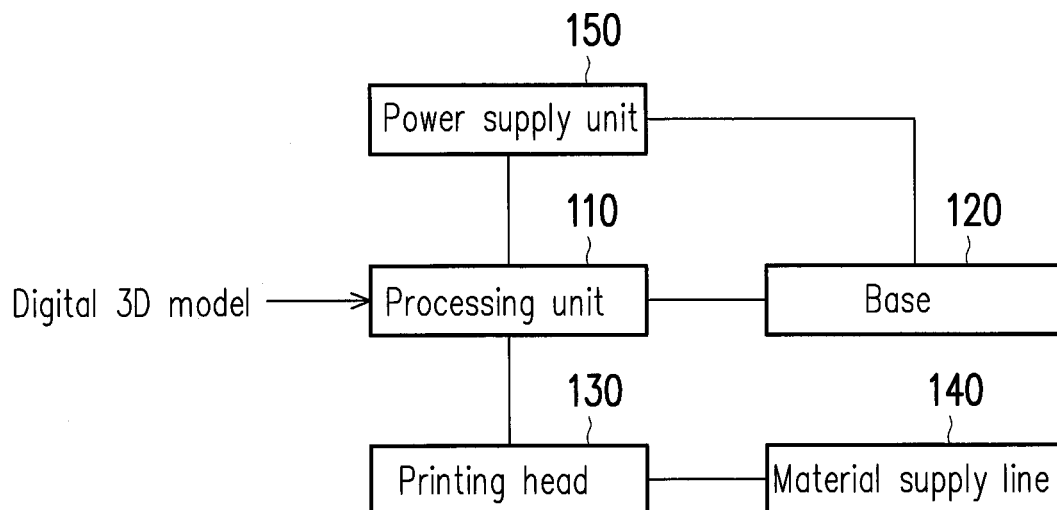


FIG. 2

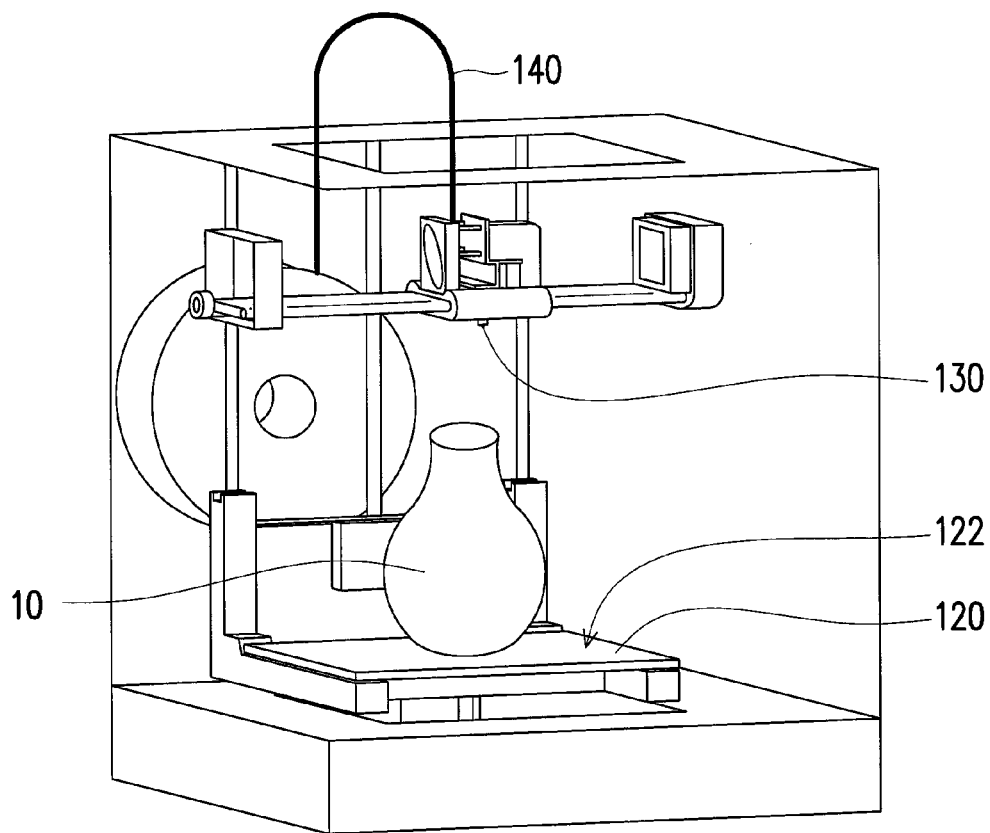


FIG. 3

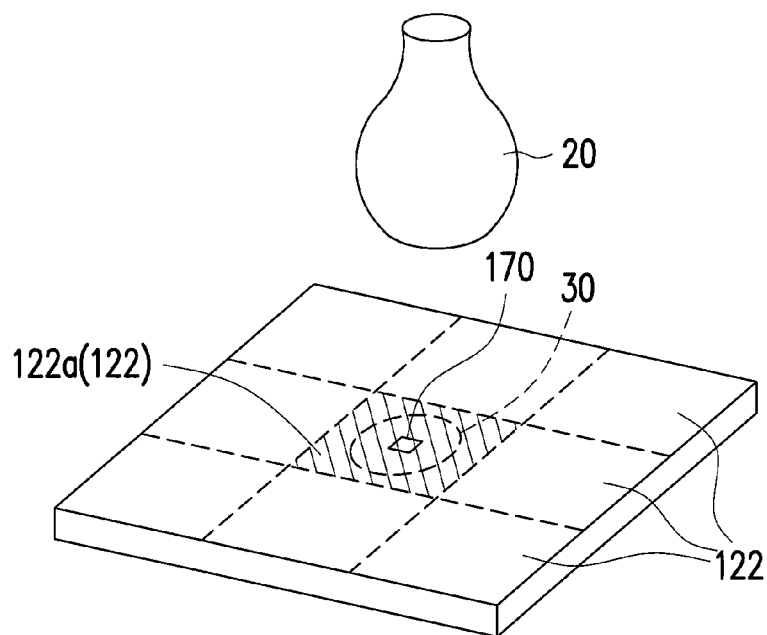


FIG. 4

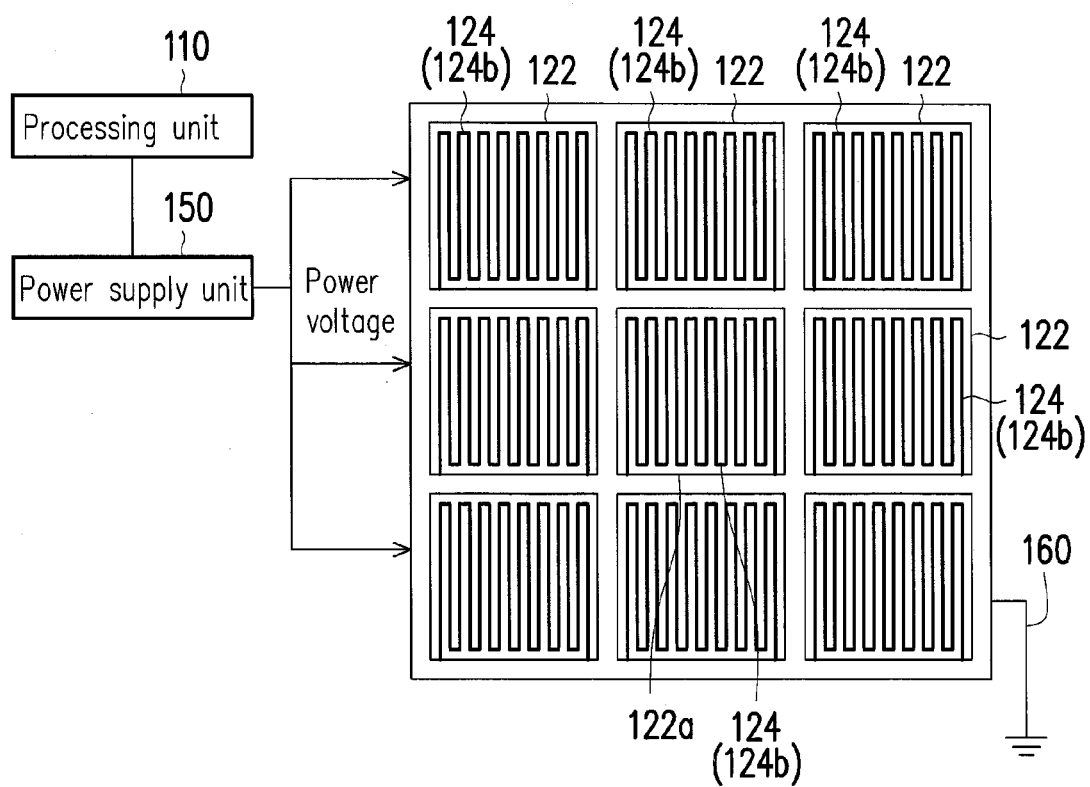


FIG. 5

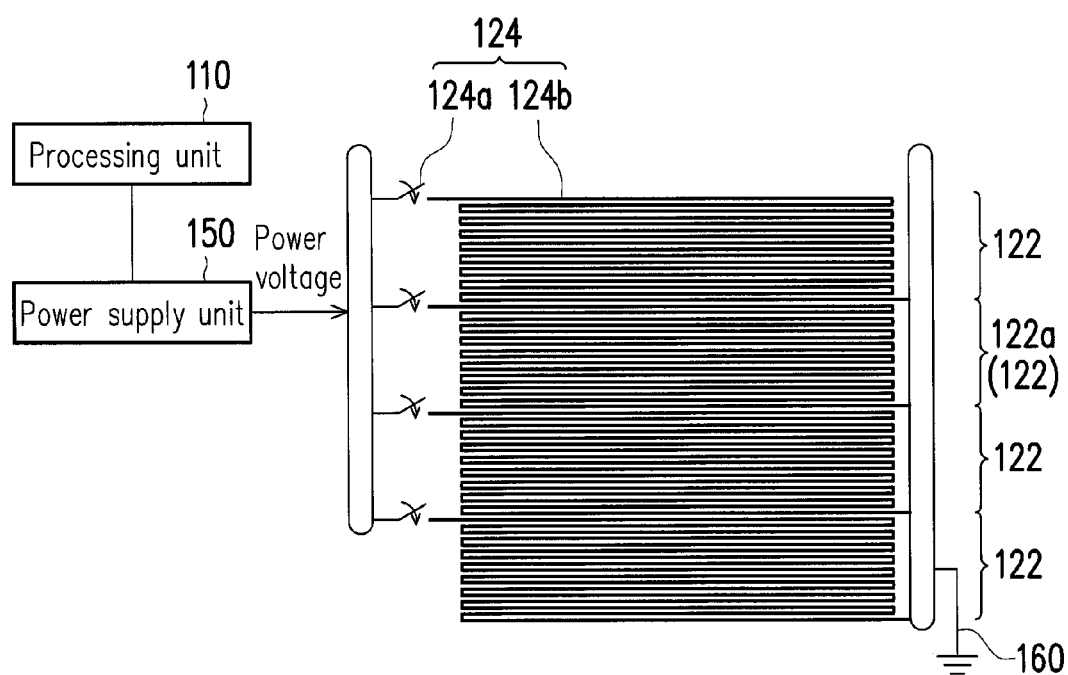


FIG. 6

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THREE-DIMENSIONAL PRINTING APPARATUS

CROSS-REFERENCE TO RELATED APPLICATION

This application claims the priority benefits of U.S. provisional application Ser. No. 61/869,079, filed on Aug. 23, 2013 and Taiwan application serial no. 102137158, filed on Oct. 15, 2013. The entirety of each of the above-mentioned patent applications is hereby incorporated by reference herein and made a part of this specification.

BACKGROUND

1. Technical Field

The invention relates to a printing apparatus. Particularly, the invention relates to a three-dimensional printing apparatus.

2. Related Art

Along with progress of computer-aided manufacturing (CAM), three-dimensional (3D) printing technology is developed to rapidly convert original design concept into physical models. The 3D printing technology is actually a general designation of a series of rapid prototyping (RP) techniques, and a basic principle thereof is additive manufacturing, where a RP machine is used to form a sectional shape of a workpiece in an X-Y plane through scanning, and intermittently shift by a layer thickness along a Z-axis, so as to form a 3D object. The 3D printing technology is not limited to any geometric shape, and the more complex the workpiece is, the more excellence the RP technology is demonstrated. The 3D printing technology can greatly save manpower and processing time, and under a demand of shortest time, digital 3D model information designed by software of 3D computer-aided design (CAD) can be truly presented as a physical part, which is not only touchable, a user can also actually feel a geometric curve of the physical part, and can test assembling ability of the physical part, or even perform possible functional tests.

In a current 3D printing apparatus that produces 3D parts according to the aforementioned RP technique, a base used for carrying a thermal melting constructing material is required to be continually heated during the manufacturing process of the 3D part, so as to maintain a temperature of the base to be higher than a curing temperature of the thermal melting constructing material, to prevent the thermal melting constructing material from cooling down too quickly and cured. However, since the above method has to maintain a melting state of the thermal melting constructing material in the process of printing, the base of the 3D printing apparatus has to be continuously heated, which leads to a higher cost and uneasy machine maintenance.

SUMMARY

The invention is directed to a three-dimensional printing apparatus, in which a base thereof is capable of being separately heated in different regions, so as to reduce manufacturing cost and unnecessary energy waste.

The invention provides a three-dimensional (3D) printing apparatus including a processing unit, a base and a printing head. The processing unit is configured to read and process digital 3D model information. The base is coupled to and controlled by the processing unit. The base includes a plurality of heating regions. The processing unit is configured to selectively heat at least one of the heating regions according to the digital 3D model information. The printing head is

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disposed above the base. The printing head is coupled to and controlled by the processing unit to dispense a thermal melting material layer-by-layer on the heated heating region to form a 3D object related to the digital 3D model information.

According to the above descriptions, in the embodiment of the invention, the base of the 3D printing apparatus includes a plurality of heating regions, such that the 3D printing apparatus is capable of controlling the base to selectively heat at least one of the heating regions according to the digital 3D model information, and controlling the printing head to dispense the thermal melting material on the heated heating region to form a 3D object related to the digital 3D model information. In this way, the 3D printing apparatus is unnecessary to heat the whole base, but selectively heats at least one of the heating regions according to the digital 3D model information. Therefore, operation and maintenance cost of the 3D printing apparatus of the invention are reduced and unnecessary energy waste is also reduced.

In order to make the aforementioned and other features and advantages of the invention comprehensible, several exemplary embodiments accompanied with figures are described in detail below.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings are included to provide a further understanding of the invention, and are incorporated in and constitute a part of this specification. The drawings illustrate embodiments of the invention and, together with the description, serve to explain the principles of the invention.

FIG. 1 is a schematic diagram of an operation environment of a three-dimensional (3D) printing apparatus according to an embodiment of the invention.

FIG. 2 is a partial block diagram of a 3D printing apparatus according to an embodiment of the invention.

FIG. 3 is a three-dimensional view of a part of components of a 3D printing apparatus according to an embodiment of the invention.

FIG. 4 is a schematic diagram of a base of a 3D printing apparatus according to an embodiment of the invention.

FIG. 5 is a schematic diagram of a part of components of a 3D printing apparatus according to an embodiment of the invention.

FIG. 6 is a schematic diagram of a part of components of a 3D printing apparatus according to another embodiment of the invention.

DETAILED DESCRIPTION OF DISCLOSED EMBODIMENTS

The present invention will now be described more fully with reference to the accompanying drawings, in which exemplary embodiments of the invention are shown. The terms used herein such as "above", "below", "front", "back", "left" and "right" are for the purpose of describing directions in the figures only and are not intended to be limiting of the invention. Moreover, in following embodiments, the same or similar reference numbers denote the same or similar components.

FIG. 1 is a schematic diagram of an operation environment of a three-dimensional (3D) printing apparatus according to an embodiment of the invention. FIG. 2 is a partial block diagram of the 3D printing apparatus according to an embodiment of the invention. FIG. 3 is a three-dimensional view of a part of components of the 3D printing apparatus according to an embodiment of the invention. Referring to FIG. 1 to FIG. 3, in the present embodiment, the 3D printing apparatus 100

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is adapted to print a 3D object **10** according to digital 3D model information, and the 3D printing apparatus **100** includes a processing unit **110**, a base **120** and a printing head **130**. In the present embodiment, the digital 3D model information can be a digital 3D image file, which may be, for example, constructed by a computer host **200** by using software of computer-aided design (CAD) or animation modeling software, etc. The processing unit **110** is configured to read and process the digital 3D model information.

The base **120** has a carrying surface **122**, which is used for carrying a thermal melting material dispensed by the printing head **130**. In the present embodiment, the 3D printing apparatus **100** further includes at least one material supply line **140**, which is coupled to the printing head **130** for supplying the thermal melting material to the printing head **130**. The printing head **130** is disposed above the base **120**, and the processing unit **110** is coupled to the printing head **130** and controls the printing head **130** to dispense the thermal melting material onto the carrying surface **122** of the base **120** layer-by-layer to form the 3D object **10**. In the present embodiment, the material supplying line **140** can be a solid-state line made of thermal melting material, and the solid-state line can be heated by a heating unit of the printing head to melt the thermal melting material, and the melted thermal melting material is extruded from the printing head **130**, and is stacked on the carrying surface **122** layer-by-layer from bottom to top, so as to form a plurality of thermal melting material layers, and the thermal melting material layers are stacked to form the 3D object **10**. In the present embodiment, the thermal melting material is, for example, a thermal-melting polymer material such as polylactic acid (PLA) or acrylonitrile butadiene styrene (ABS), etc. It should be noticed that the thermal melting material printed on the carrying surface **122** layer by layer by the printing head **130** generally includes a constructing material used for constructing the 3D object **10** and a supporting material used for supporting the 3D object **10**. Namely, the thermal melting material printed on the carrying surface **122** is not only used for constructing the 3D object **10**, but is also used for constructing a supporting part or a base used for supporting the 3D object **10**, and after the thermal melting material formed on the carrying surface **122** is cured, the supporting material used for supporting the 3D object **10** can be removed to obtain the 3D object **10**.

According to the above descriptions, during the process that the printing head **130** dispenses the thermal melting material layer-by-layer on the base **120**, the 3D printing apparatus **100** can separately heat the base **120** according to, for example, the size of a bottom layer of the digital 3D model information. Namely, the base **120** includes a plurality of heating regions, and the 3D printing apparatus **100** can selectively heat at least one of the heating regions according to the digital 3D model information, so as to maintain a temperature of the heated heating region to be higher than a curing temperature of the thermal melting material, and prevent the thermal melting material from quickly cooling down and cured. Moreover, after printing task of the 3D printing apparatus **100** is completed, a curing and drying process can be performed to the 3D object **10** on the base **120**. In this way, manufacturing of the 3D object **10** is preliminarily completed.

FIG. 4 is a schematic diagram of the base of the 3D printing apparatus according to an embodiment of the invention. Referring to FIG. 2 to FIG. 4, in detail, in the present embodiment, the processing unit **110** is coupled to and controls the printing head **130** and the base **120**, where the base **120** includes a plurality of heating regions **122** as that shown in FIG. 4. After the processing unit **110** reads digital 3D model

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information **20**, the processing unit **110** selectively heats at least one of the heating regions **122** according to the digital 3D model information **20**. In detail, the digital 3D model information **20** may include bottom layer distribution data related to the heating region **122** to be heated of the base **120**. Further, the digital 3D model information **20** includes a plurality of cross section data related to cross-sections of the 3D object **10**, and the bottom layer distribution data is distribution data of a bottom cross section of the 3D object **10** directly contacting the base **120**, which is corresponded to a plane coordinate of the base **120** to obtain the heating region **122a** to be heated on the base **120**. The processing unit **110** may correspond the digital 3D model information **20** to a plane coordinate **30** of the base **120**, for example, converts the bottom layer distribution data of the digital 3D model information **20** into the plane coordinate of the base **120**, so as to obtain a position and a distribution area of the 3D object **10** related to the digital 3D model information **20** and about to be formed on the base **120**. Then, the plane coordinate **30** corresponds to at least one of the heating regions **122** (for example, the heating region **122a** in FIG. 4), and the processing unit **110** controls the base **120** to heat the heating region (for example, the heating region **122a** in FIG. 4) corresponding to the plane coordinate **30** according to the plane coordinate.

Moreover, in the present embodiment, the 3D printing apparatus **100** further includes a temperature sensing element **170** disposed in a central region of the base **120** for sensing a temperature of the base **120**. For example, the temperature sensing element **170** is, for example, a thermistor. Further, the temperature sensing element **170** may be a negative temperature coefficient (NTC) thermistor, and a resistance value thereof is decreased as the temperature is increased. The processing unit **110** is coupled to the temperature sensing element **170**, and deduces a temperature of the base **120** according to the resistance value of the temperature sensing element **170**, and controls the temperature of the heated heating region **122a** to be within a specific range. In the present embodiment, the temperature of the heated heating region **122a** is maintained to about 120 degrees to 150 degrees.

According to the above descriptions, the processing unit **110** controls the printing head **130** to dispense the thermal melting material on the heated heating region **122a** layer-by-layer to form the 3D object **10** related to the digital 3D model information **20**. After the 3D object **10** is formed, the processing unit **110** controls the base **120** to stop heating the heating region **122a**. In this way, the 3D printing apparatus **100** is unnecessary to heat the whole base **120**, but controls the base **120** to selectively heat at least one of the heating regions **122** according to the digital 3D model information **20**, i.e. only heat the selected heating region **122a** corresponding to the bottom layer distribution data of the digital 3D model information **20**, so as to maintain the temperature of the heating region **122a** to be higher than the curing temperature of the thermal melting material formed thereon. In this way, operation and maintenance cost of the 3D printing apparatus **100** of the present embodiment are reduced and unnecessary energy waste is also reduced.

FIG. 5 is a schematic diagram of a part of components of the 3D printing apparatus according to an embodiment of the invention. Referring to FIG. 3 and FIG. 5, in the present embodiment, the base **120** may further include a plurality of heating modules **124**, and the heating modules **124** are respectively coupled to the processing unit **110** and are disposed corresponding to the heating regions **122**. Each of the heating modules **124** may include a heating resistor **124b**. The processing unit **110** controls at least one of the heating mod-

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ules **124** to heat the selected heating region **122a** to be heated according to the digital 3D model information **20**. In detail, the 3D printing apparatus **100** may further include a power supply unit **150** and a ground line **160**. The power supply unit **150** is coupled to and controlled by the processing unit **110** for providing a power supply voltage, and the ground line **160** is used for providing a ground voltage. Each of the heating modules **124** is coupled between the power supply unit **150** and the ground line **160**.

According to the above descriptions, the processing unit **110** controls the power supply unit **150** to provide the power supply voltage to at least one of the heating modules **124** according to the digital 3D model information **20**. Namely, the processing unit **110** determines the heating region **122a** to be heated (for example, the heating region **122a** in the middle as that shown in FIG. 5) of the heating regions **122** according to the bottom layer distribution data of the digital 3D model information **20**, and controls the power supply unit **150** to provide the power supply voltage to the corresponding heating module **124**, so as to heat the heating region **122a** to be heated. Certainly, the figure of the embodiment is only an example, and the number of the heating regions **122a** to be heated is not limited by the invention, and in other embodiments of the invention, if the bottom layer distribution data simultaneously corresponds to a plurality of heating regions **122a** in the base **120**, the processing unit **110** can control to simultaneously heat the plurality of heating regions **122a** according to the bottom layer distribution data.

In this way, the processing unit **110** controls the printing head **130** to dispense the thermal melting material on the heated heating region **122a** layer-by-layer, so as to form the 3D object **10** related to the digital 3D model information **20**. After the 3D object **10** is formed, the processing unit **110** controls the power supply unit **150** to stop providing the power supply voltage to the heating module **124**, and performs a cooling or curing process to the 3D object **10** to complete manufacturing the 3D object **10**.

It should be noticed that reference numbers of the components and a part of contents of the aforementioned embodiment are also used in the following embodiment, wherein the same reference numbers denote the same or like components, and descriptions of the same technical contents are omitted. The aforementioned embodiment can be referred for descriptions of the omitted parts, and detailed descriptions thereof are not repeated in the following embodiment.

FIG. 6 is a schematic diagram of a part of components of a 3D printing apparatus according to another embodiment of the invention. Referring to FIG. 3 and FIG. 6, the 3D printing apparatus of the present embodiment is similar to the 3D printing apparatus of FIG. 5, the base **120** of the present embodiment may also include a plurality of heating modules **124**, and the heating modules **124** are respectively coupled to the processing unit **110** and are disposed corresponding to the heating regions **122**. The 3D printing apparatus **100** may also include the power supply unit **150** and the ground line **160**. The power supply unit **150** is coupled to and controlled by the processing unit **110** for providing a power supply voltage and the ground line **160** is used for providing a ground voltage. A main difference between the 3D printing apparatus of the present embodiment and the 3D printing apparatus of FIG. 5 is that each of the heating modules **124** includes a switch **124a** and a heating resistor **124b**, and each of the heating resistors **124b** is coupled to the ground line **160** and is coupled to the power supply unit **150** through the corresponding switch **124a**. In the present embodiment, the switches **124a** are, for example, N-type transistors. Certainly, those with ordinary skills in the art should understand that besides the N-type

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transistors, the switches can be implemented by P-type transistors, multiplexers, transmission gates, relays, etc., which is not limited by the invention.

According to the above descriptions, the processing unit **110** turns on at least one of the switches **124a** according to the digital 3D model information **20**, which enables the power supply unit **150** to provide the power supply voltage to the heating resistor **124b** corresponding to the turned-on switch **124a**. Namely, the processing unit **110**, for example, selects at least one of the heating regions **122** as the heating region **122a** to be heated according to the bottom layer distribution information of the digital 3D model information **20**, and turns on the switch **124a** of the corresponding heating module **124**, such that the power supply unit **150** can provide the power supply voltage to the corresponding heating resistor **124b** to heat the heating region **122a** to be heated. Certainly, the figure of the embodiment is only an example, and the number of the heating regions **122a** to be heated is not limited by the invention, and in other embodiments of the invention, if the bottom layer distribution data simultaneously corresponds to a plurality of heating regions **122a** in the base **120**, the processing unit **110** can control to simultaneously heat the plurality of heating regions **122a** according to the bottom layer distribution data.

In this way, the processing unit **110** controls the printing head **130** to dispense the thermal melting material on the heated heating region **122a** layer-by-layer, so as to form the 3D object **10** related to the digital 3D model information **20**. After the 3D object **10** is formed, the processing unit **110** controls to turn off the switch **124a**, so as to stop heating the heating region **122a**, and performs a cooling or curing process to the 3D object **10** to complete manufacturing the 3D object **10**.

In summary, the base of the 3D printing apparatus includes a plurality of heating regions, such that the 3D printing apparatus can selectively heat at least one of the heating regions according to the digital 3D model information constructed through, for example, a computer host, and control the printing head to dispense the thermal melting material on the heated heating region to form a 3D object related to the digital 3D model information. In this way, the 3D printing apparatus is unnecessary to heat the whole base, but selectively heats the heating region corresponding to a position on the base where the 3D object is set to be formed, so as to maintain the temperature of the heated heating region to be higher than the curing temperature of the thermal melting material dispensed thereon. Therefore, the operation and maintenance cost of the 3D printing apparatus of the invention are reduced and unnecessary energy waste is also reduced.

It will be apparent to those skilled in the art that various modifications and variations can be made to the structure of the invention without departing from the scope or spirit of the invention. In view of the foregoing, it is intended that the invention cover modifications and variations of this invention provided they fall within the scope of the following claims and their equivalents.

What is claimed is:

1. A three-dimensional (3D) printing apparatus, comprising:
 - a processing unit, configured to read and process digital 3D model information;
 - a base, coupled to and controlled by the processing unit, wherein the base comprises a plurality of heating modules and a plurality of heating regions, the heating modules are coupled to the processing unit and disposed corresponding to the heating regions, and the processing unit is configured to control the heating modules to

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selectively heat at least one of the heating regions according to the digital 3D model information, wherein the digital 3D model information comprises bottom layer distribution data, and the bottom layer distribution data corresponds to a plane coordinate of the base, the processing unit controls the base to heat the at least one heating region to be heated according to the plane coordinate; and

a printing head, disposed above the base, wherein the printing head is coupled to and controlled by the processing unit to dispense a thermal melting material layer-by-layer on the at least one heated heating region, so as to form a 3D object related to the digital 3D model information.

2. The 3D printing apparatus as claimed in claim 1, wherein after the processing unit controls the printing head to dispense the thermal melting material layer by layer on the at least one heated heating region to form the 3D object, the processing unit controls the base to stop heating the at least one heated heating region.

3. The 3D printing apparatus as claimed in claim 1, further comprising a power supply unit and a ground line, wherein the power supply unit is coupled to and controlled by the processing unit for providing a power supply voltage, and the ground line is configured to provide a ground voltage, each of the heating modules is coupled between the power supply unit and the ground line, and the processing unit controls the power supply unit to provide the power supply voltage to at least one of the heating modules corresponding to the at least one selected heating region according to the digital 3D model information.

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4. The 3D printing apparatus as claimed in claim 3, wherein after the processing unit controls the printing head to dispense the thermal melting material layer by layer on the at least one heated heating region to form the 3D object, the processing unit controls the power supply unit to stop supplying the power supply voltage to the heating modules.

5. The 3D printing apparatus as claimed in claim 1, further comprising a power supply unit and a ground line, wherein the power supply unit is coupled to and controlled by the processing unit for providing a power supply voltage, and the ground line is configured to provide a ground voltage, each of the heating modules comprises a switch and a heating resistor, each of the heating resistors is coupled to the ground line, and is coupled to the power supply unit through the corresponding switch, and the processing unit turns on at least one of the switches according to the digital 3D model information, so as to provide the power supply voltage to the corresponding heating resistor to heat the at least one selected heating region.

6. The 3D printing apparatus as claimed in claim 5, wherein after the processing unit controls the printing head to dispense the thermal melting material layer-by-layer on the heated heating region to form the 3D object, the processing unit turning off the switches.

7. The 3D printing apparatus as claimed in claim 1, further comprising a temperature sensing element disposed on the base and coupled to the processing unit for sensing a temperature of the base, wherein the processing unit obtains the temperature of the base through the temperature sensing element, and accordingly controls the temperature of the at least one heated heating region to be within a specific range.

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